

### FEATURES

- Fully Autonomous USB Type-C® and USB PD Sink Controller
- USB Type-C® Specification Reversion 2.1 and USB PD Specification Reversion 3.1 Supported
- Maximum 48V/5A PDO Supported
  - GPIO Mode: Maximum 28 V/3.25 A EPR FPDO and EPR AVS
  - I<sup>2</sup>C Mode: Maximum 48 V/5 A EPR FPDO, EPR AVS and SPR PPS
- Automatic Legacy Protocols Detection Including BC1.2, Divider 3, QC2.0
- Support SOP' Detection
- Typical Low Power Operation: I<sub>VDD</sub> < 75  $\mu$ A
- Integrated VBUS Switch Driver
- Dead Battery Support
- VBUS Over-voltage Protection (OVP) and Under-voltage Protection (UVP)
- Over-temperature Protection (OTP) with Programmable Thresholds
- 2 kV HBM ESD Rating for USB IO Pins
- Small Package, 16 Lead QFN (3 mm x 3 mm)

### APPLICATIONS

USB PD Sink Devices  
Wireless Charger

### GENERAL DESCRIPTION

The **HUSB238A** is a highly integrated stand-alone USB Type-C® and Power Delivery (PD) Sink controller. The **HUSB238A** integrates the CC logic, USB PD protocol and the legacy protocols.

The **HUSB238A** can run in I<sup>2</sup>C mode and GPIO mode. In I<sup>2</sup>C mode, an I<sup>2</sup>C master can access the **HUSB238A** to configure settings, read back status and perform advanced functions such as DR Swap, VDM messages. The **HUSB238A** supports APDO, maximum 48 V/5 A EPR FPDO and EPR AVS in I<sup>2</sup>C mode.

While in GPIO mode, the configuration is achieved via the setting pins. The **HUSB238A** can be configured to support maximum 28V/3.25A PDO via VSET and ISET pins, only two resistors are used to set the voltage and current.

The ultra-low operation current of the **HUSB238A** helps the system to reduce the total power dissipation and suitable for a battery application.

The **HUSB238A** is available in QFN 3 mm x 3 mm-16L package.

### TYPICAL APPLICATION CIRCUIT

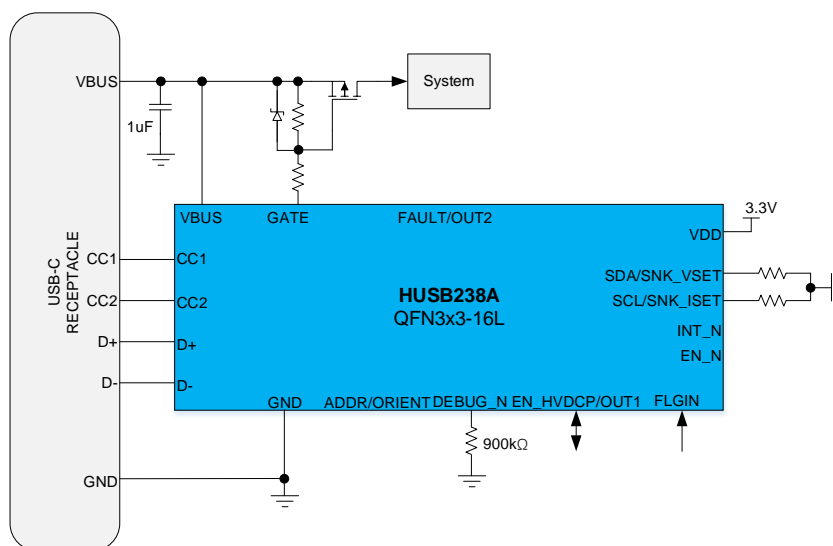


Figure 1. Typical Application Circuit

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**REVISION HISTORY**

Version	Date	Descriptions
Rev. 1.0	07/2024	Initial version

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PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

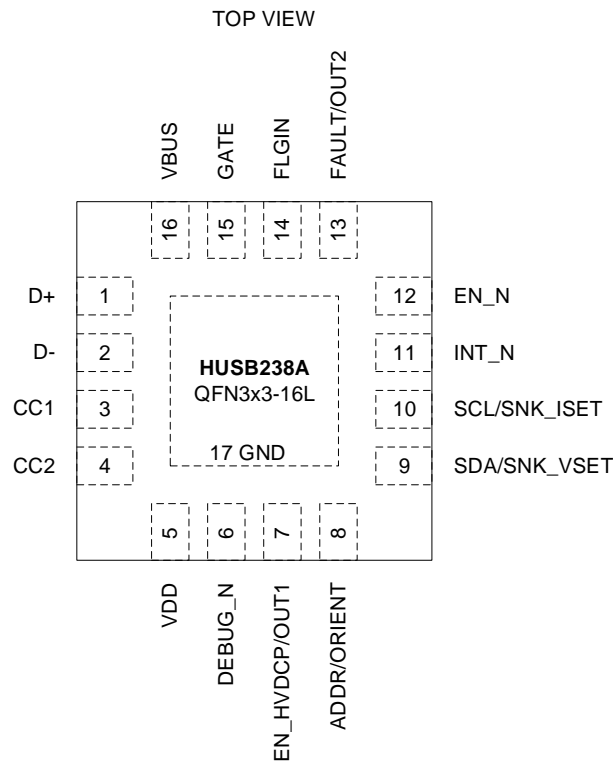


Figure 2. HUSB238A Pin Assignment

Table 1. HUSB238A-XXXXX-QN16R Pin Function Descriptions

Pin No.	Pin Name	Type1	Description
1	D+	IO	Positive line of the USB data line pair.
2	D-	IO	Negative line of the USB data line pair.
3	CC1	IO	USB Type-C CC1 line.
4	CC2	IO	USB Type-C CC2 line.
5	VDD	P	Input supply 1 for internal circuitry. It is recommended to tie this pin to the single cell battery or a 3.3 V power rail. When the power is not available this pin, the VBUS pin may power the internal circuitry if it is available. Place a 1µF ceramic capacitor across this pin and GND pin.
6	DEBUG_N	IO	This pin is push-pull output to indicate the Debug Accessory Detection results. Low = Debug Accessory detected High = Debug Accessory not detected A 900 kΩ resistor has to be placed this pin to GND pin.
7	EN_HVDCP/OUT1	IO	<b>Dual function pin.</b> In input mode, this pin (EN_HVDCP) is a digital input pin to enable the HVDCP protocol detection in Sink mode. The HUSB238A may perform different actions depending on the connection: Connected to GND = Only perform BC1.2 detection Connected to VDD = Perform HVDCP detection after BC1.2 DCP is detected In output mode, this pin (OUT1) is push-pull output whose output status can be configured by I <sup>2</sup> C. Note: a 900 kΩ resistor should be used when connecting to VDD or GND to reduce standby current.

Pin No.	Pin Name	Type1	Description
8	ADDR/ORIENT	IO	<p>For the <a href="#">HUSB238A-AAXXX-QN16R</a>, this pin should keep floating. For the <a href="#">HUSB238A-BBXXX-QN16R</a>, this pin is a <b>Dual function pin</b>. In input mode, this pin (ADDR) is a 3 state input to set the working mode. The working mode is defined as below, depending on the connection:</p> <p>Connected to VDD = I<sup>2</sup>C mode with slave address 62H</p> <p>Connected to GND = I<sup>2</sup>C mode with slave address 42H</p> <p>Float = GPIO mode</p> <p>In output mode, this pin (ORIENT) is push-pull output to indicate the connection status.</p> <p>Low = CC1 of USB Type-C receptacle is connected</p> <p>High = CC2 of USB Type-C receptacle is connected</p> <p>Note: a 900 kΩ resistor should be used when connecting to VDD or GND to reduce standby current.</p>
9	SDA/SNK_VSET	AIO	<p><b>Dual functions pin</b>. In I<sup>2</sup>C mode (only for the <a href="#">HUSB238A-BBXXX-QN16R</a>), this pin (SDA) is the data line of I<sup>2</sup>C bus.</p> <p>In GPIO mode, this pin (SNK_VSET) combined with SNK_ISET to determine the requested voltage.</p>
10	SCL/SNK_ISET	AIO	<p><b>Dual functions pin</b>. In I<sup>2</sup>C mode (only for the <a href="#">HUSB238A-BBXXX-QN16R</a>), this pin (SDA) is the clock line of I<sup>2</sup>C bus.</p> <p>In GPIO mode, this pin (SNK_ISET) combined with SNK_VSET to determine the requested current.</p>
11	INT_N	AIO	In I <sup>2</sup> C mode (only for the <a href="#">HUSB238A-BBXXX-QN16R</a> ), this pin (INT_N) is an open-drain output to request the attention of processor by pulling down this pin. For the <a href="#">HUSB238A-AAXXX-QN16R</a> , keep this pin floating.
12	EN_N	AI	Chip enabled pin. It is pulled up internally and <a href="#">HUSB238A</a> is enabled by pulling this pin to GND.
13	FAULT/OUT2	DO	General output pin. The output purpose can be configured as a FAULT pin. When used as FAULT pin, the device pulls this pin high if the power adapter cannot supply the required voltage or current or if an OVP/UVF/OTP event is detected. This pin can be also configured as General output pin (OUT2) controller by I <sup>2</sup> C master (only for the <a href="#">HUSB238A-BBXXX-QN16R</a> ).
14	FLGIN	DI	General input pin. This input signal can be used to disable the GATE driver and generate an interrupt when there is a valid high voltage is detected. It can be also configured as just an interrupt source for INT_N, not disabling GATE driver.
15	GATE	O	Open drain output. This pin is employed to control the external VBUS switch.
16	VBUS	P	This pin has multiple functions including VBUS voltage detection, the discharge path for VBUS pin and the Input supply 2 for internal circuitry. When VDD is unpowered, the <a href="#">HUSB238A</a> consumes power from this pin.
17	GND	P	Ground connection point

Legend:

A = Analog Pin

P = Power Pin

D = Digital Pin

I = Input Pin

O = Output Pin

## RECOMMENDED OPERATING CONDITIONS

Table 2.

Parameter	Rating
VDD Input Voltage	3 V to 5.5 V
VBUS Input Voltage (VDD is available)	3.15 V to 29.4 V
VBUS Input Voltage (VDD is unavailable)	4.5 V to 29.4 V
Operating Temperature Range (Junction)	-40 °C to 125 °C
Ambient Temperature Range	-40 °C to 85 °C

## SPECIFICATIONS

$V_{DD} = 3 \text{ V to } 5.5 \text{ V}$  or  $V_{DD} < 3 \text{ V}$  and  $VBUS = 4.5 \text{ V to } 29.4 \text{ V}$ ,  $T_J = -40 \text{ °C to } 125 \text{ °C}$  for minimum and maximum specifications, and  $T_A = 25 \text{ °C}$  for typical specifications, unless otherwise noted.

Table 3.

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
Power Supply						
VDD UVLO Rising Threshold	$V_{DD\_UVLO\_R}$	Power Up to normal operation	2.65	2.75	2.85	V
VDD UVLO Hysteresis	$V_{DD\_UVLO\_HYS}$	Hysteresis Voltage to be shutdown		0.1		V
VDD Standby Current	$I_{STBY}$	EN_N=Low without attachment, $V_{DD}=4.5 \text{ V}$ & $VBUS=0 \text{ V}$		50	75	$\mu\text{A}$
VDD Operating Current in Active Mode	$I_{OP\_VDD}$	EN_N=Low and attached as an Active Sink, $V_{DD}=4.5 \text{ V}$ & $VBUS=5 \text{ V}$		4	4.5	mA
VBUS UVLO Threshold	$V_{BUS\_UVLO\_R}$	$V_{DD}=0 \text{ V}$	3.67	4	4.4	V
VBUS UVLO Hysteresis	$V_{BUS\_UVLO\_HYS}$	Hysteresis Voltage to be shutdown		0.1		V
VBUS Operating Current in Active Mode	$I_{OP\_VBUS}$	EN_N=Low and attached as an Active Sink, $V_{DD}=0 \text{ V}$ & $VBUS=29.4 \text{ V}$		4	4.5	mA
Open Drain Output Pins (GATE, INT_N)						
Output Low Voltage	$V_{OL\_OD}$	Sink current=2 mA			0.4	V
Enable Pin (EN_N)						
Low Level Input Threshold	$V_{IL\_EN}$				0.4	V
High Level Input Threshold	$V_{IH\_EN}$		1.35			V
Input and Output Pins (DEBUG_N, ADDR/ORIENT, EN_HVDCP/OUT1)						
High Level Input Threshold	$V_{IH\_IO}$		$0.8 \cdot V_{DD}$			V
Output Low Voltage	$V_{OL\_PP}$	Sink current=1 mA			$0.2 \cdot V_{DD}$	V
Output High Voltage	$V_{OH\_PP}$	Source current=1 mA	$0.8 \cdot V_{DD}$			V
I <sup>2</sup> C Characteristics (SDA, SCL pins for the HUSB238A-BBXXX-QN16R)						
Output Low Voltage	$V_{OL\_I2C}$	Sink current is 2 mA			0.4	V
Input Low Voltage	$V_{IL\_I2C}$	I <sup>2</sup> C Pull up voltage is 3.3 V			0.99	V
Input High Voltage	$V_{IH\_I2C}$	I <sup>2</sup> C Pull up voltage is 3.3 V	2.31			V
Input Voltage Hysteresis	$V_{HYS\_I2C}$	I <sup>2</sup> C Pull up voltage is 3.3 V	0.17			V
SCL Clock Frequency	$f_{SCL\_I2C}$		0		400	kHz
Analog Input Pins (SNK_ISET, SNK_VSET)						
Pull up Source Current	$I_{SNK\_VSET}$	On SNK_VSET pin	95	100	105	$\mu\text{A}$

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
SNK_VSET Setting Resistor	ISNK_ISET	On SNK_ISET pin	95	100	105	μA
	RSNK_VSET0	VSET_VOLTAGE=5 V	0		2	kΩ
	RSNK_VSET1	VSET_VOLTAGE=9 V	2.85	3	3.15	kΩ
	RSNK_VSET2	VSET_VOLTAGE=12 V	5.7	6	6.3	kΩ
	RSNK_VSET3	VSET_VOLTAGE=15 V	10.45	11	11.55	kΩ
	RSNK_VSET4	VSET_VOLTAGE=20 V	18.05	19	19.95	kΩ
SNK_VSET Setting Resistor	RSNK_VSET5	VSET_VOLTAGE=28 V	1			MΩ
	RSNK_ISET0	ISET_CURRENT=1.25 A	0		1.5	kΩ
	RSNK_ISET1	ISET_CURRENT=1.5 A	2.137	2.25	2.362	kΩ
	RSNK_ISET2	ISET_CURRENT=1.75 A	3.8	4	4.2	kΩ
	RSNK_ISET3	ISET_CURRENT=2 A	5.7	6	6.3	kΩ
	RSNK_ISET4	ISET_CURRENT=2.25 A	7.98	8.4	8.82	kΩ
	RSNK_ISET5	ISET_CURRENT=2.5 A	10.925	11.5	12.075	kΩ
	RSNK_ISET6	ISET_CURRENT=2.75 A	14.82	15.6	16.38	kΩ
	RSNK_ISET7	ISET_CURRENT=3 A	19.95	21	22.05	kΩ
	RSNK_ISET8	ISET_CURRENT=3.25 A	1			MΩ
Type-C Pins (CC1, CC2)						
Sink Pull Down Resistor	Rd	In Sink Mode	4.6	5.1	5.6	kΩ
CC Over-voltage Threshold	VCCOV	For any CC pin, VDD > VDD_UVLO_R		VDD+3		V
		For any CC pin, VDD < (VDD_UVLO_R-0.1 V)		6.3		V
VBUS Present and Protection						
VBUS Present Rising Threshold	vVBPRS_R	Rising edge to set VBUS_OK=1b	3.67	4	4.4	V
VBUS Present Hysteresis	vVBPRS_HYS	Hysteresis Voltage to set VBUS_OK=0b		0.7		V
VBUS UV falling Threshold	vVBUV_F0	Falling edge to detect disconnection when 26 V > RDO > 10 V, refer to the requested voltage		86		%
	vVBUV_F1	Falling edge to detect disconnection when 10 V ≥ RDO > 5 V, refer to the requested voltage		80		%
	vVBUV_F2	Falling edge to detect disconnection when RDO ≥ 26 V		22.4		V
VBUS UV Hysteresis	vVBUV_HYS			0.1		V
VBUS Over-voltage Threshold	VBUS_OV	Refer to the requested voltage		120		%
VBUS Over-voltage Hysteresis	vVBov_HYS			0.1		V
BC1.2 and HVDCP Detection						
BC1.2 Source voltage	VDPM_SRC_OV6			0.6		V
D- Source Voltage for 3.3V	VDM_SRC_3P3			3.3		V
D+ Source Voltage for 3.3V	VDP_SRC_3P3			3.3		V
D- 3.3V Pull-up Resistance	RDM_SRC_3P3			1.24		kΩ
D+ 3.3V Pull-up Resistance	RDP_SRC_3P3			1.24		kΩ
Data Detect Voltage	VDAT_REF			325		mV
Digital Input Pin (FLGIN)						
Digital Input High Voltage	VIH_GPIO	VI_GPIO for 3.3 V	2			V
Digital Input Low Voltage	VIL_GPIO	VI_GPIO for 3.3 V			0.8	V

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
Digital Output Pin (FAULT/OUT2)						
Output Low Voltage	V <sub>OL_PP</sub>	Sink current=1 mA			0.2V <sub>DD</sub>	V
Output High Voltage	V <sub>OH_PP</sub>	Source current=1 mA	0.8V <sub>DD</sub>			V
Thermal Shut Down						
Thermal Shut Down Threshold	T <sub>TSD_R</sub>	Rising Threshold		150		°C
	T <sub>TSD_F</sub>	Falling Threshold		130		°C
TSW Debounce Time	t <sub>DB_TSW</sub>			100		ms
TSD Debounce Time	t <sub>DB_TSD</sub>			1000		ms



## ABSOLUTE MAXIMUM RATINGS

Table 4.

Parameter	Rating
VBUS, GATE, CC1, CC2	–0.3 V to 33 V
D+, D–, ADDR/ORIENT, VDD, INT_N, SDA/SNK_VSET, SCL/SNK_ISET, EN_HVDCP/OUT1, FLGIN, EN_N, FAULT/OUT2, DEBUG_N	–0.3 V to 7 V
Operating Temperature Range (Junction)	–40 °C to 125 °C
Soldering Conditions	JEDEC J-STD-020
Electrostatic Discharge (ESD) Human Body Model	±2000 V

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Close attention to PCB thermal design is required.

$\theta_{JA}$  is the natural convection junction to ambient thermal resistance measured in a one cubic foot sealed enclosure.

$\theta_{JC}$  is the junction to case thermal resistance.

Table 5. Thermal Resistance

Package Type	$\theta_{JA}$	$\theta_{JC}$	Unit
QFN3x3-16L	70	41	°C/W

## ESD CAUTION



### Electrostatic Discharge Sensitive Device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

FUNCTIONAL BLOCK DIAGRAM

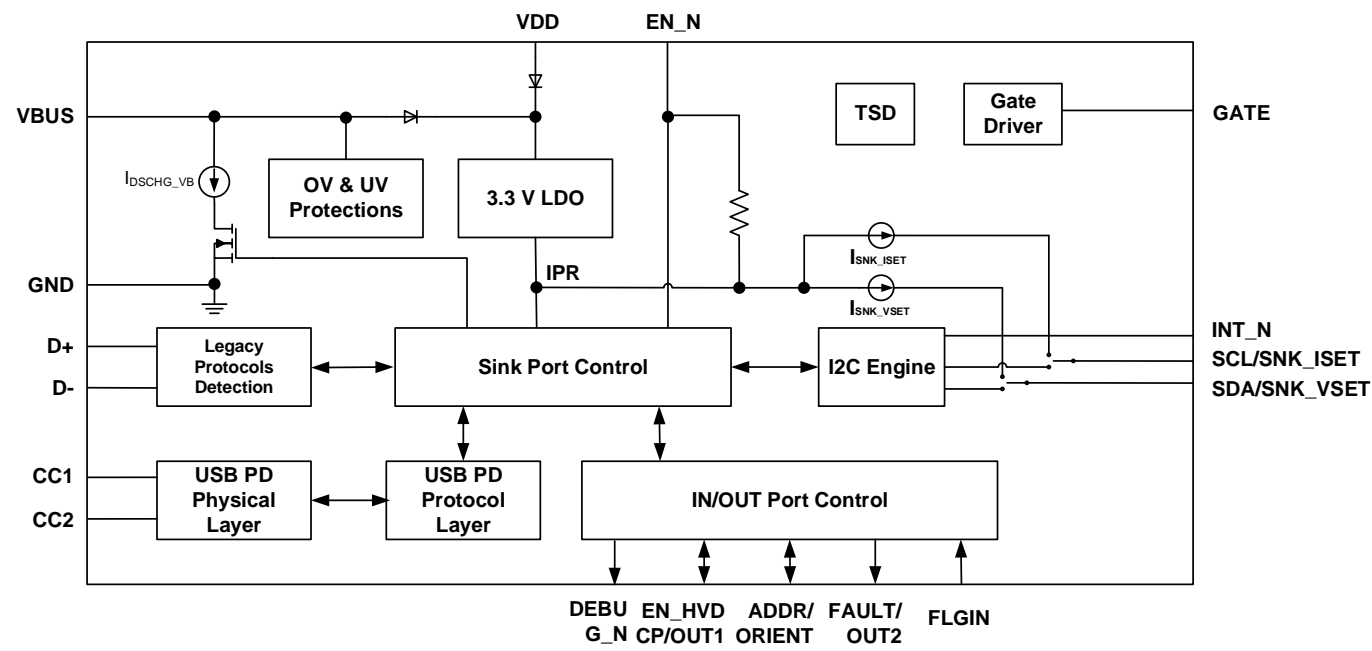


Figure 3. Functional Block Diagram

## THEORY OF OPERATION

The **HUSB238A** is a USB PD Sink controller. It supports PD protocol and legacy charging protocols detection and requests the desired power per the user settings. The **HUSB238A** can run in I<sup>2</sup>C mode (only for the **HUSB238A-BBXXX-QN16R**) and GPIO mode. In I<sup>2</sup>C mode, an I<sup>2</sup>C master can access the **HUSB238A** to configure settings, read back status and perform advanced functions such as DR Swap, VDM messages. While in GPIO mode, the configuration is achieved via the setting pins.

### ENABLE CONTROL

**HUSB238A** has an enable pin (EN\_N) for the whole system control. When EN\_N is high, the whole system is disabled, When EN\_N is low, the whole system is enabled.

When EN\_N is low, and **HUSB238A** is in I<sup>2</sup>C mode (only for the **HUSB238A-BBXXX-QN16R**), there is an additional ENABLE bit to enable or disable the **HUSB238A**, when this ENABLE bit is 0b, all of functions of **HUSB238A** is turned off except the I<sup>2</sup>C accessibility, EN\_N detection and UVLO detection. Only when the ENABLE=1b, the disabled functions resume to work.

### ADDR/ORIENT PIN

For ADDR/ORIENT pin, it is employed to select whether **HUSB238A** works as I<sup>2</sup>C mode (only for the **HUSB238A-BBXXX-QN16R**) or GPIO mode.

**Table 6. Work Mode Configuration**

ADDR/ORIENT Connection	HUSB238A Work Mode Configured
Connected to VDD via a 900kΩ Resistor	I <sup>2</sup> C mode with slave address=62H
Floating (MUST for <b>HUSB238A-AAXXX-QN16R</b> )	GPIO mode
Connected to GND via a 900kΩ Resistor	I <sup>2</sup> C mode with slave address=42H

### EN\_HVDCP/OUT1 PIN

For EN\_HVDCP/OUT1 pin, it is employed to determine whether **HUSB238A** can support HVDCP detection.

**Table 7. Legacy Protocol Detection Configuration**

EN_HVDCP/OUT1 Connection	HUSB238A Legacy Protocol Detection
Connected to VDD via a 900kΩ Resistor	Perform BC1.2 and HVDCP protocols
Floating	Perform BC1.2 and HVDCP protocols
Connected to GND via a 900kΩ Resistor	Only perform BC1.2 detection

### VBUS PIN

The VBUS pin has multiple functions for the applications. It could be an input power source, the discharging path and the monitor pin for protections and disconnection.

### ANALOG INPUT PINS

After the initialization, the **HUSB238A** is able to output the status of current connection. When ADDR/ORIENT is floating during initialization, **HUSB238A** is in GPIO mode. In this mode, the SDA/SNK\_VSET, SCL/SNK\_ISET pins are repopulated as analog input pins.

### SNK\_VSET PIN

This pin is used to set the request voltage. This pin is pulled up internally. Connect a resistor with 1% tolerance between SNK\_VSET and GND to indicate the SNK\_VSET\_VOLTAGE value as shown in Table 8.

**Table 8. SNK\_VSET Setting**

R <sub>SNK_VSET</sub> (kΩ)	Preferred Voltage (V)
0	5
3	9
6.04	12
11	15
19.1	20

<b>R<sub>SNK_VSET</sub> (kΩ)</b>	<b>Preferred Voltage (V)</b>
Open	28 (if EPR_CAP_SNK=0b, then 20)

The RDO voltage of the [HUSB238A](#) is determined by the lower value between SNK\_VSET and SNK\_PDO2\_VOLTAGE. SNK\_PDO2\_VOLTAGE is programmable by internal fuse options and the default value is 20 V. The requested voltage value can be changed dynamically with the resistance value change in GPIO mode.

### **SNK\_ISET PIN**

This pin is used to set the request current. This pin is pulled up internally. Connect a resistor with 1% tolerance between SNK\_ISET and GND to indicate the ISET\_CURRENT value as shown in Table 9.

**Table 9. SNK\_ISET Setting**

<b>R<sub>SNK_ISET</sub> (kΩ)</b>	<b>Preferred CURENT (A)</b>
0	1.25
2.26	1.5
4.02	1.75
6.04	2
8.45	2.25
11.5	2.5
15.8	2.75
21	3
Open	3.25

The RDO current of the [HUSB238A](#) is determined by the lower value between ISET\_CURRENT and SNK\_PDO2\_CURRENT. SNK\_PDO2\_CURRENT is programmable by internal fuse options and the default value is 3.25 A. The requested current value can be changed dynamically with the resistance value change in GPIO mode.

### **DIGITAL PINS**

There are two additional digital pins for extended application. The two pins are FLGIN and FAULT/OUT2.

#### **FAULT/OUT2**

The FAULT/OUT2 pin is a digital output pin. It can be assigned as several functions.

**Fault Indication:** Output Low in default. The [HUSB238A](#) pulls this pin high when a fault occurs.

**ID Indication:** This pin indicates connection state.

**Table 10. ID Indication Definition**

<b>ID Status</b>	<b>Description</b>
Low	Attached as a Source
High-Z	Attached as a Sink or unattached

**OUT2:** Extended output pin, I<sup>2</sup>C master can write the register bit to change the output state.

#### **FLGIN**

The FLGIN pin is a digital input pin. It is an input source for interrupt. This interrupt can be set INT\_N low if it is not masked. Furthermore, this input signal can be mapped to disable GATE pin immediately by I<sup>2</sup>C master.

### **INPUT AND OUTPUT PINS**

There are 3 pins that are implemented by dual functions. They are all input and output pins. However, they perform input pin only during initialization when the [HUSB238A](#) determines the settings by these pin. After the initialization, these pins switches to output pin with push-pull output. These pins are DEBUG\_N, EN\_HVDCP/OUT1 and ADDR/ORIENT.

#### **DEBUG\_N PIN**

The DEBUG\_N pin is a push-pull output that indicate [HUSB238A](#) connection status in Table 11:

**Table 11. DEBUG\_N Pin Definition**

<b>DEBUG_N Status</b>	<b>Description</b>
Low	Debug Accessory detected

DEBUG_N Status	Description
High	Debug Accessory not detected

**ORIENT PIN**

The ORIENT pin is a push-pull output that indicate [HUSB238A](#) connection status in Table 12.

**Table 12. ORIENT Pin Definition**

ORIENT Status	Description
Low	CC1 is connected or Not connected
High	CC2 is connected

**OUT1 PIN**

The OUT1 pin is purely a general output pin, I<sup>2</sup>C master can write the register bit to change the output state.

**CC LOGIC**

The [HUSB238A](#) is able to support the USB Type-C Rev.2.1. CC1 and CC2 pins are used to detect the attachment or detachment with the external devices.

**SOP VDM MESSAGES**

The [HUSB238A](#) supports Structured VDMs. Therefore, the Discover Identity, Discover SVIDs, Discover Modes, Enter Mode and Exit Mode Commands are all supported by the [HUSB238A](#). The [HUSB238A](#) can transmit Structure VDMs controlled by I<sup>2</sup>C master.

**POLICY ENGINE**

The following sections describes the system policy for typical applications.

**SINK REQUESTED POWER DETERMINATION**

The request data object (RDO) could be determined in different ways in different modes.

**RDO IN GPIO MODE**

The [HUSB238A](#) can request different voltage per the predetermined settings. There are two ways where the request voltage can be set. One is the configuration of SNK\_ISET and SNK\_VSET pin and another way is the SNK\_RDO2 Configurations. The [HUSB238A](#) compares the two values and uses the lower value as its target RDO in GPIO mode.

For example, if the SNK\_VSET and SNK\_ISET is configured as 9V / 3A. The SNK\_RDO2 Configurations is 12V / 2A. Then the RDO that [HUSB238A](#) requests from the PD source is 9V / 2A.

After the RDO is determined, the [HUSB238A](#) loops through the PD source PDOs from highest voltage first to find the first PDO that satisfies the following conditions:

1. SOURCE\_PDO\_VOLTAGE  $\leq$  RDO\_VOLTAGE
2. SOURCE\_PDO\_CURRENT  $\geq$  RDO\_CURRENT

If both the conditions above are satisfied, then [HUSB238A](#) sends a request for this source PDO with operating current set to the RDO current value.

If either one of the condition is not satisfied, the [HUSB238A](#) continues to compare with the second highest voltage source PDO or requests 5V source PDO directly, depending on the RDO\_VOLTAGE\_SELECT.

The RDO results are also suitable for legacy charging protocol request. When performing the legacy charging protocol detection, the request voltage is also determined by this RDO results.

**RDO IN I<sup>2</sup>C MODE**

Additionally, in I<sup>2</sup>C mode, [HUSB238A](#) can access the internal registers to dynamic change the RDO by I<sup>2</sup>C bus. After initialization, the [HUSB238A](#) may receive the Source Capabilities message from the PD source adapter and the [HUSB238A](#) saves the source capability information in registers SRC\_PDO\_5V to SRC\_PDO\_20V. The I<sup>2</sup>C master can visit the [HUSB238A](#) registers through the I<sup>2</sup>C bus and select a proper PDO by setting SRC\_PDO register and then writing 0x01 to GO\_COMMAND register.

The I<sup>2</sup>C master has the highest priority. If using I<sup>2</sup>C master to select a source PDO, it over writes the internal RDO which is created by SNK\_VSET, SNK\_ISET pins and internal factory fuse option, and the HUSB238A requests the I<sup>2</sup>C master selected source PDO once the I<sup>2</sup>C commands are written.

## **LEGACY CHARGER DETECTION**

After the power on reset, the HUSB238A runs the PD PE or Apple Divider 3 and BC1.2 detections after the connection is established.

## **EMARKER EMULATION**

The HUSB238A is able to respond a Discover Identity message in SOP' format anytime.

## **FAULT RESPONSE**

The HUSB238A implements multiple protections to prevent any damage from failure. CCOV, OVP, UV, TSD, UVLO are all involved.

## **CC OVER VOLTAGE PROTECTION**

Since CC1 and CC2 in Type-C connector is very close to VBUS pin, it is possible that the CC1 and CC2 pins are shorted to VBUS pin in some unexpected cases. It is important to guarantee that the CC1 and CC2 pins can be survived under such accidents. When the CC over-voltage condition occurs, the HUSB238A enters fault mode.

## **OVER VOLTAGE PROTECTION**

The HUSB238A detects the VBUS pin voltage to achieve over-voltage protection function. The OVP threshold is changed with the Requested Voltage. When the over-voltage condition occurs, the HUSB238A enters fault Mode.

## **UNDER VOLTAGE PROTECTION**

The HUSB238A detects the VBUS pin voltage to achieve a disconnection detection. When the under voltage fault occurs, the HUSB238A moves out the Attached.SNK state.

## **THERMAL SHUT DOWN**

The HUSB238A integrates thermal shut down function. It monitors the internal junction temperature. If the junction temperature reaches the thermal shut down threshold  $T_{TSD\_R}$  for  $t_{TSD}$ , the TSD fault can be set to entry the fault mode.

## **I<sup>2</sup>C MODE**

After the initialization, the HUSB238A is able to output the status of current connection. When ADDR/ORIENT is connected to VDD or GND during initialization (only allowed for the HUSB238A-BBXXX-QN16R), HUSB238A is in I<sup>2</sup>C mode. In this mode, the INT\_N, SDA/SNK\_VSET, SCL/SNK\_ISET pins are repopulated as I<sup>2</sup>C interface pins.

## **INT\_N**

The INT\_N pin is an active LOW open drain interruption output used to prompt the processor to access the I<sup>2</sup>C registers. An external pull-up resistor is recommended for INT\_N pin to output a high voltage level when this pin is not active.

## **SCL AND SDA**

The HUSB238A implements a Fast-mode I<sup>2</sup>C interface. The SCL and SDA pins can detect the status of the input signals and drive the I<sup>2</sup>C bus when needed.

## **DEAD BATTERY**

The HUSB238A works as PD sink role which requires Rd resistor to be presented on the CC pins even in the un-powered state for successful Type-C detection by source adapter.

## **SLEEP MODE**

The HUSB238A has a specified Sleep Mode to save the power consumption from VDD or VBUS. This function can be enabled or disabled by internal fuse option.

## TYPICAL APPLICATION CIRCUITS

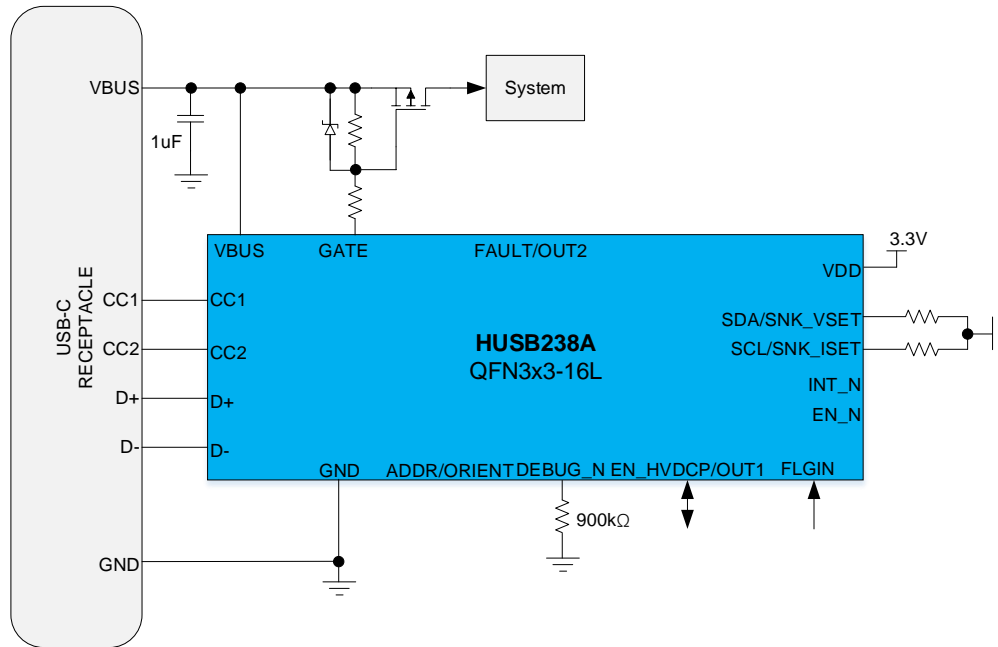


Figure 4. HUSB238A configured as GPIO mode (Maximum 28V)

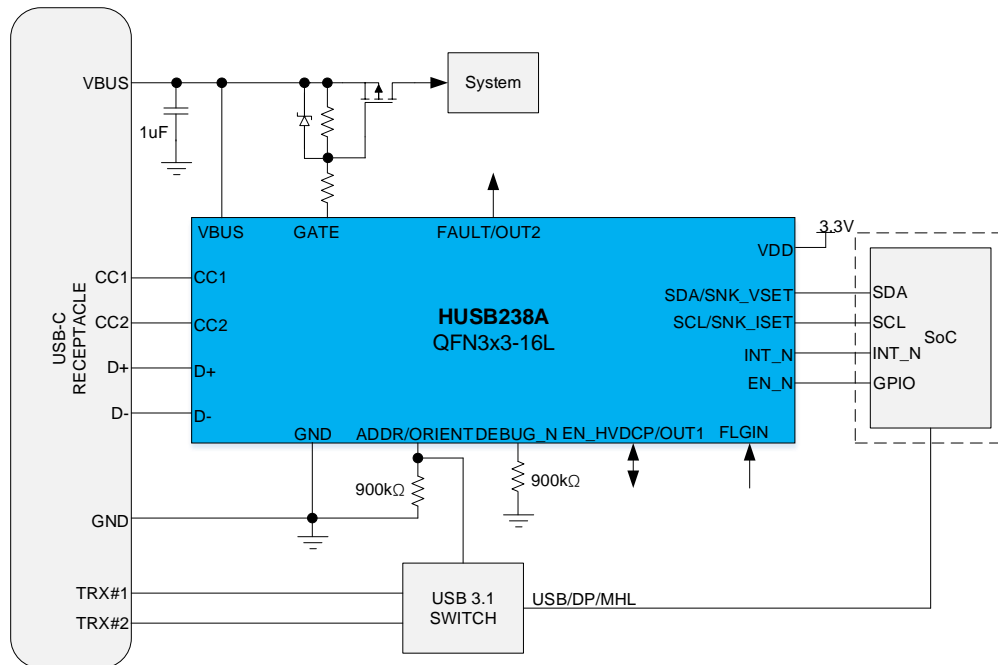


Figure 5. HUSB238A configured as PC mode (Maximum 28V)

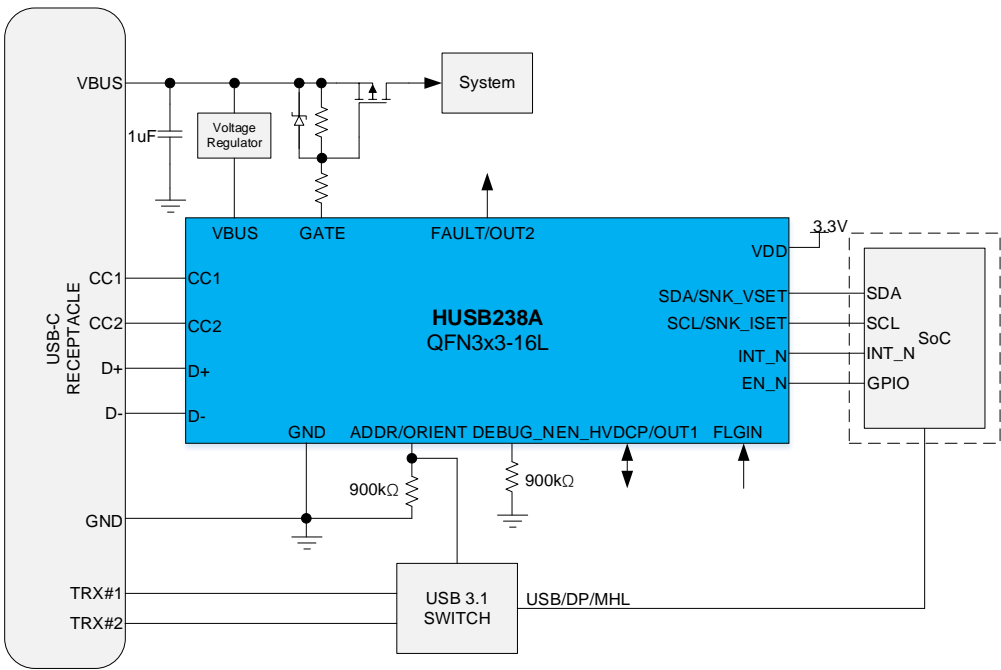
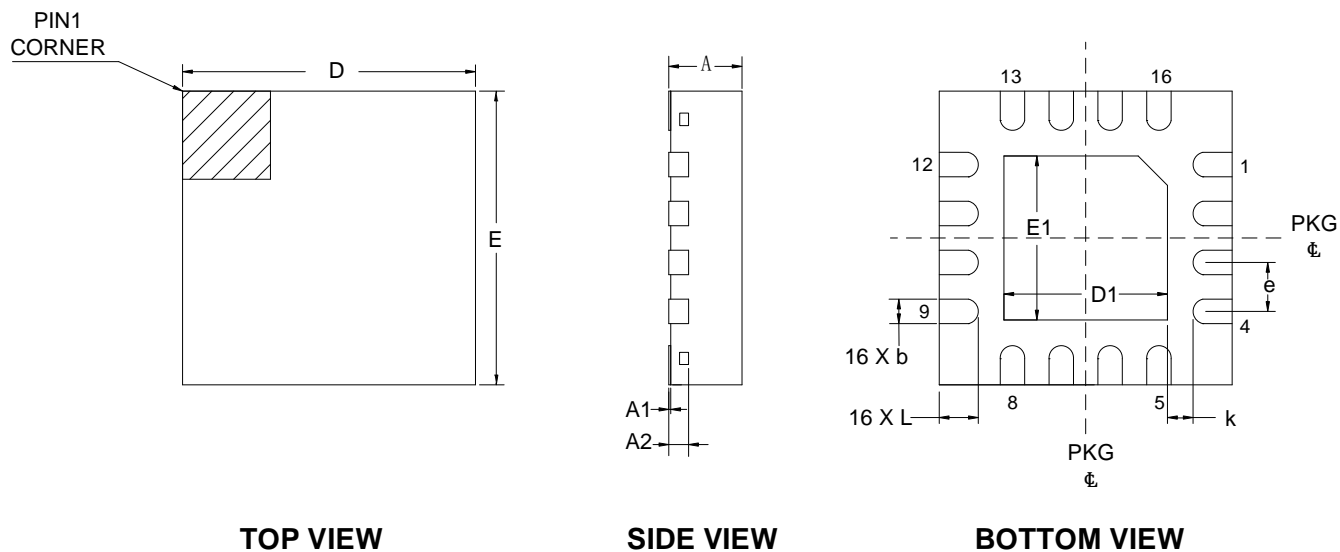


Figure 6. HUSB238A configured as I<sup>2</sup>C mode (Maximum 48V)



## PACKAGE OUTLINE DIMENSIONS



SYMBOLS	DIMENSION IN MILLIMETERS		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A2	0.203 REF		
b	0.18	0.25	0.30
D	3.00 BSC		
E	3.00 BSC		
D1	1.55	1.70	1.80
E1	1.55	1.70	1.80
e	0.50 BSC		
L	0.30	0.40	0.50
k	0.20 MIN.		

Figure 7. QFN 3 mm x 3 mm -16L Package

PACKAGE TOP MARKING

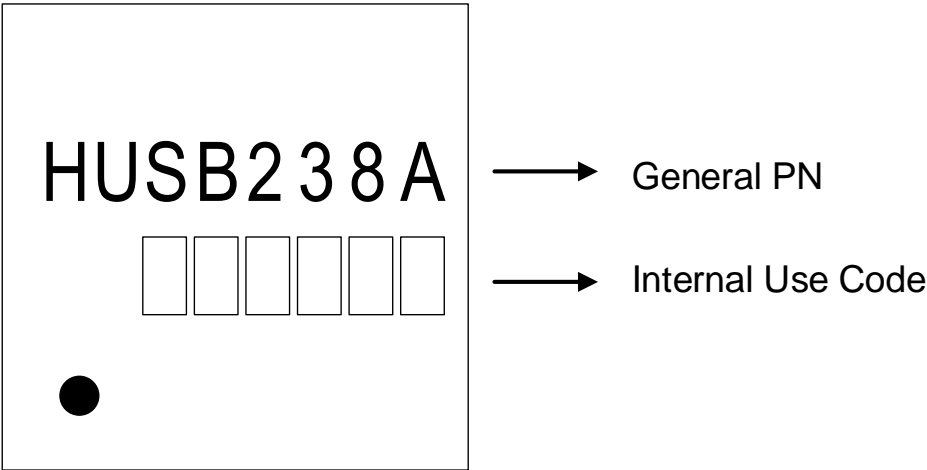


Figure 8. Package Top Marking

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**ORDERING GUIDE**

Model	Package	SOP'	SNK_PDO2	RDO Mismatch	Package Option
HUSB238A-BB001-QN16R	QFN3X3-16L	NO	28V/3A	Next PDO	Tape & Reel, 5000
HUSB238A-BB002-QN16R	QFN3X3-16L	YES	28V/3A	Next PDO	Tape & Reel, 5000
HUSB238A-BB003-QN16R	QFN3X3-16L	NO	20V/3A	Next PDO	Tape & Reel, 5000
HUSB238A-BB004-QN16R	QFN3X3-16L	NO	5V/3A	Next PDO	Tape & Reel, 5000

TAPE AND REEL INFORMATION

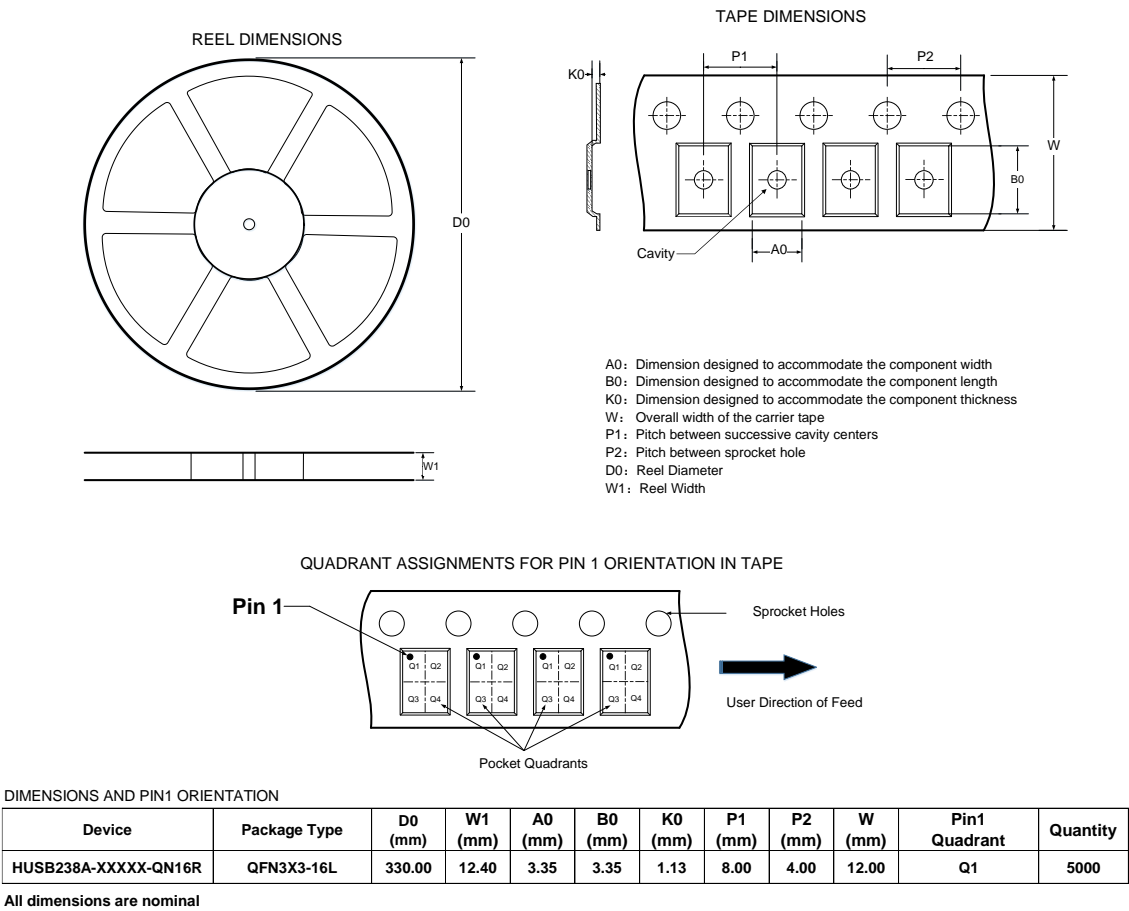


Figure 9. Tape and Reel Information

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